

Applicant(s):	Brian A. Vaartstra et al.)	Group Art Unit:	2815
)		
Serial No.:	09/603,132)	Examiner:	Eugene Lee
Confirmation No.:	3538)		
)		
Filed:	23 June 2000)		
)		
For:	DEVICE STRUCTURES INCLUDING RUTHENIUM SILICIDE DIFFUSION BARRIER LAYERS			

Commissioner for Patents
Mail Stop Issue Fee
P.O. Box 1450
Alexandria, VA 22313-1450


Please recognize as the "Fee Address" under the provisions of 37 C.F.R. §1.363 the following address:

Micron Technology, Inc.
8000 South Federal Way
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Customer Number 26809

in the following listed application(s) or patent(s) for which the Issue Fee has been paid.

PATENT NUMBER	SERIAL NUMBER	PATENT DATE	U.S. FILING DATE
	09/603,132		June 23, 2000

Typed name of person signing Loren D. Albin
Signed 
Date June 9, 2009

(check one) Owner of record
 X Owner's attorney or agent of record Reg No. 37,763